

High-Voltage - High Power Transistors

MJE4343 (NPN), MJE4353 (PNP)

... designed for use in high power audio amplifier applications and high voltage switching regulator circuits.

Features

• High Collector–Emitter Sustaining Voltage –

$$V_{CEO(sus)} = 160 \text{ Vdc} - \text{MJE4343} \text{ MJE4353}$$

- High DC Current Gain @ I_C = 8.0 Adc h_{FE} = 35 (Typ)
- Low Collector-Emitter Saturation Voltage -

$$V_{CE(sat)} = 2.0 \text{ Vdc (Max)} @ I_{C}$$

= 8.0 Adc

• These are Pb-Free Devices

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	160	Vdc
Collector-Base Voltage	V_{CB}	160	Vdc
Emitter-Base Voltage	V _{EB}	7.0	Vdc
Collector Current – Continuous Peak (Note 1)	l _C	16 20	Adc
Base Current - Continuous	Ι _Β	5.0	Adc
Total Power Dissipation @ T _C = 25°C	P_{D}	125	Watts
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

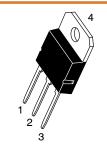
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ heta JC}$	1.0	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width \leq 5.0 μ s, Duty Cycle \geq 10%.

16 AMPS POWER TRANSISTORS COMPLEMENTARY SILICON 160 VOLTS



SOT-93 CASE 340D STYLE 1



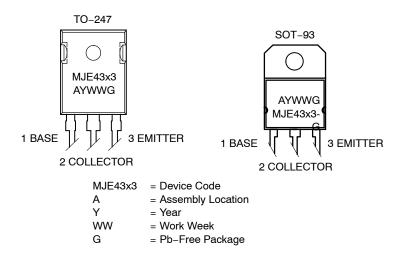
TO-247 CASE 340L STYLE 3

NOTE: Effective June 2012 this device will be available only in the TO-247 package. Reference FPCN# 16827.

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

MARKING DIAGRAMS



ORDERING INFORMATION

Device Order Number	Package Type	Shipping
MJE4343G	SOT-93 (Pb-Free)	30 Units / Rail
MJE4353G	SOT-93 (Pb-Free)	30 Units / Rail
MJE4343G	TO-247 (Pb-Free)	30 Units / Rail
MJE4353G	TO-247 (Pb-Free)	30 Units / Rail

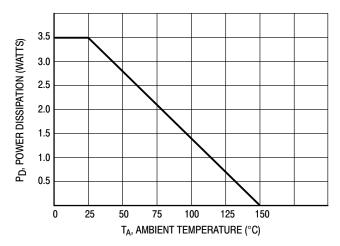


Figure 1. Power Derating Reference: Ambient Temperature

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (Note 2) $(I_C = 200 \text{ mAdc}, I_B = 0)$	V _{CEO(sus)}	160	_	Vdc
Collector-Emitter Cutoff Current (V _{CE} = 80 Vdc, I _B = 0)	I _{CEO}	_	750	μAdc
	I _{CEX}	- -	1.0 5.0	mAdc
Collector–Base Cutoff Current $(V_{CB} = Rated V_{CB}, I_E = 0)$	Ісво	-	750	μAdc
Emitter-Base Cutoff Current $(V_{BE} = 7.0 \text{ Vdc}, I_{C} = 0)$	I _{EBO}	-	1.0	mAdc
ON CHARACTERISTICS (Note 2)				
DC Current Gain ($I_C = 8.0 \text{ Adc}$, $V_{CE} = 2.0 \text{ Vdc}$) ($I_C = 16 \text{ Adc}$, $V_{CE} = 4.0 \text{ Vdc}$)	h _{FE}	15 8.0	35 (Typ) 15 (Typ)	-
Collector–Emitter Saturation Voltage ($I_C = 8.0 \text{ Adc}$, $I_B = 800 \text{ mA}$) ($I_C = 16 \text{ Adc}$, $I_B = 2.0 \text{ Adc}$)	V _{CE(sat)}	- -	2.0 3.5	Vdc
Base–Emitter Saturation Voltage ($I_C = 16$ Adc, $I_B = 2.0$ Adc)	V _{BE(sat)}	-	3.9	Vdc
Base–Emitter On Voltage ($I_C = 16 \text{ Adc}$, $V_{CE} = 4.0 \text{ Vdc}$)	V _{BE(on)}	-	3.9	Vdc
DYNAMIC CHARACTERISTICS				
Current-Gain - Bandwidth Product (Note 3) (I _C = 1.0 Adc, V _{CE} = 20 Vdc, f _{test} = 0.5 MHz)	f _T	1.0	-	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz)	C _{ob}	-	800	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width $\leq 300~\mu s$, Duty Cycle $\geq 2.0\%$.

3. $f_T = |h_{fe}| \cdot f_{test}$.

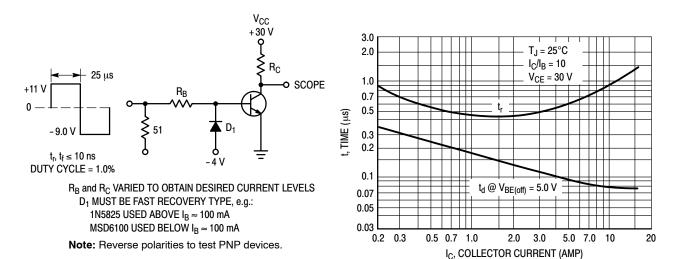


Figure 2. Switching Times Test Circuit

Figure 3. Typical Turn-On Time

TYPICAL CHARACTERISTICS

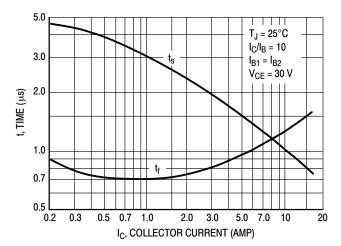


Figure 4. Turn-Off Time

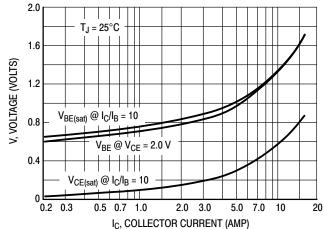


Figure 5. On Voltages

DC CURRENT GAIN

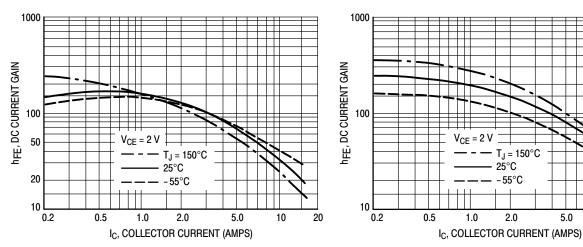


Figure 6. MJE4340 Series (NPN)

Figure 7. MJE4350 Series (PNP)

5.0

10

20

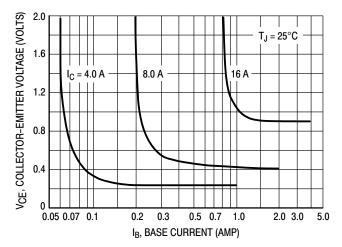


Figure 8. Collector Saturation Region

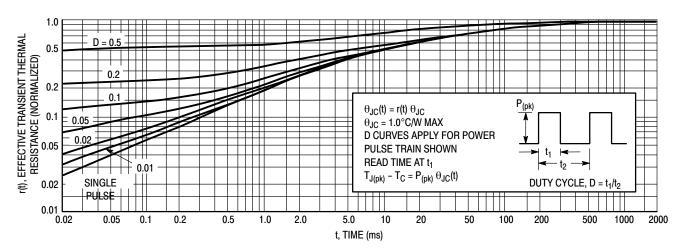


Figure 9. Thermal Response

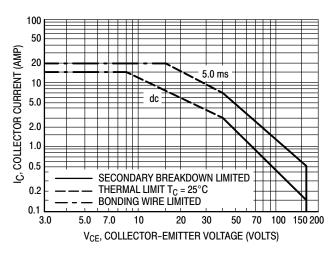


Figure 10. Maximum Forward Bias Safe Operating Area

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 11 gives RBSOA characteristics.

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 10 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25^{\circ}C$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 10 may be found at any case temperature by using the appropriate curve on Figure 9.

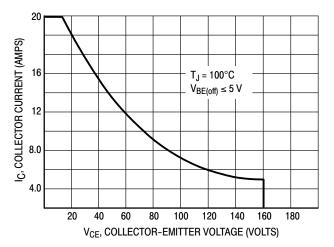
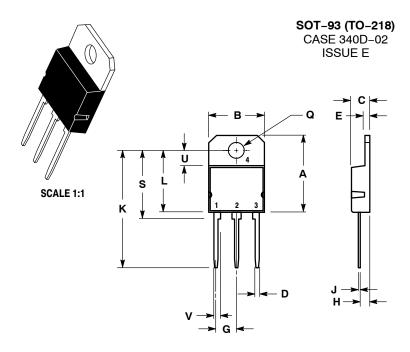


Figure 11. Maximum Reverse Bias Safe
Operating Area





STYLE 1: PIN 1. BASE

2. COLLECTOR 3. EMITTER COLLECTOR STYLE 2: PIN 1. ANODE CATHODE
 ANODE

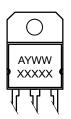
4. CATHODE

DATE 03 JAN 2002

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α		20.35		0.801
В	14.70	15.20	0.579	0.598
С	4.70	4.90	0.185	0.193
D	1.10	1.30	0.043	0.051
E	1.17	1.37	0.046	0.054
G	5.40	5.55	0.213	0.219
Н	2.00	3.00	0.079	0.118
J	0.50	0.78	0.020	0.031
K	31.00 REF		1.220	REF
L		16.20		0.638
Q	4.00	4.10	0.158	0.161
S	17.80	18.20	0.701	0.717
U	4.00 REF		0.157	REF
٧	1.75 REF		0.0)69

GENERIC MARKING DIAGRAM*



= Assembly Location

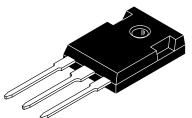
= Year WW = Work Week XXXXX = Device Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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TO-247 CASE 340L ISSUE G

DATE 06 OCT 2021

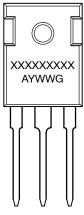
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
Α	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Ε	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
Н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
К	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242 BSC	
W	2.87	3.12	0.113	0.123

	SCALE 1:1	
N N N N N N N N N N N N N N N N N N N	B A ØQ (•) Ø0.63 (0.025) (•) T B (•) Y	SEATING PLANE T SEATING PLANE H
	⊕ 0.25 (0.010) W Y A S	

GENERIC MARKING DIAGRAM*



STYLE 1: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN

PIN 1. CATHODE 2. ANODE

3. GATE 4. ANODE

STYLE 5:

STYLE 2: PIN 1. ANODE 2. CATHODE (S) 3. ANODE 2 4. CATHODES (S)

PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

3. GATE 4. MAIN TERMINAL 2

STYLE 6:

STYLE 3: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR STYLE 4: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

XXXXX = Specific Device Code = Assembly Location Α

Υ = Year WW = Work Week G = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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